



SBOS068B - JANUARY 1997 - REVISED APRIL 2004

SINGLE-SUPPLY, microPower CMOS OPERATIONAL AMPLIFIERS microAmplifier™ Series

FEATURES

- SINGLE-SUPPLY OPERATION
- RAIL-TO-RAIL OUTPUT (within 3mV)
- microPOWER: I_O = 20μA/Amplifier
- microSIZE PACKAGES
- LOW OFFSET VOLTAGE: 125µV max
- SPECIFIED FROM V_S = 2.3V to 5.5V
- SINGLE, DUAL, AND QUAD VERSIONS

APPLICATIONS

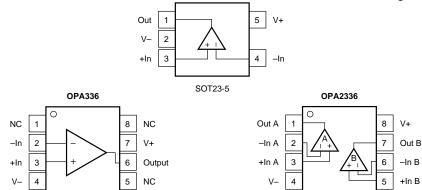
- BATTERY-POWERED INSTRUMENTS
- PORTABLE DEVICES
- HIGH-IMPEDANCE APPLICATIONS
- PHOTODIODE PRE-AMPS
- PRECISION INTEGRATORS
- MEDICAL INSTRUMENTS
- TEST EQUIPMENT

DESCRIPTION

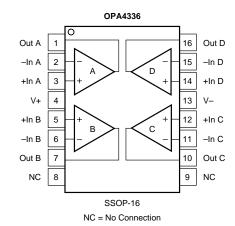
OPA336 series *micro*Power CMOS operational amplifiers are designed for battery-powered applications. They operate on a single supply with operation as low as 2.1V. The output is rail-to-rail and swings to within 3mV of the supplies with a $100 k\Omega$ load. The common-mode range extends to the negative supply—ideal for single-supply applications. Single, dual, and quad versions have identical specifications for maximum design flexibility.

In addition to small size and low quiescent current $(20\mu\text{A/amplifier})$, they feature low offset voltage $(125\mu\text{V}\text{ max})$, low input bias current (1pA), and high open-loop gain (115dB). Dual and quad designs feature completely independent circuitry for lowest crosstalk and freedom from interaction.

OPA336 packages are the tiny SOT23-5 surface mount and SO-8 surface-mount. OPA2336 come in the miniature MSOP-8 surface-mount, SO-8 surface-mount, and DIP-8 packages. The OPA4336 package is the space-saving SSOP-16 surface-mount. All are specified from -40°C to +85°C and operate from -55°C to +125°C. A macromodel is available for download (at www.ti.com) for design analysis.



OPA336





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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DIP-8, SO-8, MSOP-8

SO-8

NC = No Connection

PACKAGE/ORDERING INFORMATION(1)

PRODUCT	PACKAGE-LEAD	PACKAGE DRAWING DESIGNATOR	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER ⁽¹⁾	TRANSPORT MEDIA, QUANTITY	
Single OPA336N	SOT23-5	DBV "	-40°C to +85°C	A36 ⁽²⁾	OPA336N/250 OPA336N/3K	Tape and Reel, 250 Tape and Reel, 3000	
OPA336NA	SOT23-5	DBV "	-40°C to +85°C	A36 ⁽²⁾	OPA336NA/250 OPA336NA/3K	Tape and Reel, 250 Tape and Reel, 3000	
OPA336NJ	SOT23-5	DBV "	-40°C to +85°C	J36 "	OPA336NJ/250 OPA336NJ/3K	Tape and Reel, 250 Tape and Reel, 3000	
OPA336U	SO-8 Surface-Mount	D "	-40°C to +85°C	OPA336U "	OPA336U OPA336U/2K5	Rails ⁽³⁾ , 100 Tape and Reel, 2500	
OPA336UA	SO-8 Surface-Mount	D "	-40°C to +85°C	OPA336UA "	OPA336UA OPA336UA/2K5	Rails ⁽³⁾ , 100 Tape and Reel, 2500	
OPA336UJ ⁽⁴⁾	SO-8 Surface-Mount	D "	-40°C to +85°C	OPA336UJ "	OPA336UJ OPA336UJ/2K5	Rails ⁽³⁾ , 100 Tape and Reel, 2500	
Dual OPA2336E	MSOP-8 Surface-Mount	DGK	-40°C to +85°C	B36 ⁽²⁾	OPA2336E/250 OPA2336E/2K5	Tape and Reel, 250 Tape and Reel, 2500	
OPA2336EA	MSOP-8 Surface-Mount	DGK "	-40°C to +85°C	B36 ⁽²⁾	OPA2336EA/250 OPA2336EA/2K5	Tape and Reel, 250 Tape and Reel, 2500	
OPA2336P	DIP-8	Р	-40°C to +85°C	OPA2336P	OPA2336P	Rails, 50	
OPA2336PA	DIP-8	Р	-40°C to +85°C	OPA2336PA	OPA2336PA	Rails, 50	
OPA2336U	SO-8 Surface-Mount	D "	11	OPA2336U "	OPA2336U OPA2336U/2K5	Rails ⁽³⁾ , 100 Tape and Reel, 2500	
OPA2336UA "	SO-8 Surface-Mount	D "	-40°C to +85°C	OPA2336UA "	OPA2336UA OPA2336UA/2K5	Rails ⁽³⁾ , 100 Tape and Reel, 2500	
Quad OPA4336EA	SSOP-16 Surface-Mount	DBQ "	-40°C to +85°C	OPA4336EA "	OPA4336EA/250 OPA4336EA/2K5	Tape and Reel, 250 Tape and Reel, 2500	

NOTES: (1) For the most current package and ordering information, see the package option addendum at the end of this data sheet. (2) Grade will be marked on the Reel. (3) SO-8 models also available in Tape and Reel. (4) Available Q2, 2004.

ABSOLUTE MAXIMUM RATINGS(1)

Supply Voltage	
Signal Input Terminals, Voltage(2)	
Current ⁽²⁾	10mA
Output Short-Circuit ⁽³⁾	Continuous
Operating Temperature	55°C to +125°C
Storage Temperature	55°C to +125°C
Junction Temperature	150°C
Lead Temperature (soldering, 10s)	300°C

NOTES: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only. Functional operation of the device at these conditions, or beyond the specified operating conditions, is not implied. (2) Input terminals are diode-clamped to the power supply rails. Input signals that can swing more than 0.3V beyond the supply rails should be current-limited to 10mA or less. (3) Short-circuit to ground, one amplifier per package.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



ELECTRICAL CHARACTERISTICS: $V_S = 2.3V$ to 5.5V

Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}C$ to $+85^{\circ}C$.

At T_A = +25°C, V_S = +5V, and R_L = 25k Ω connected to $V_S/2$, unless otherwise noted.

			DPA336N, PA2336E,		OPA23	OPA336NA, UA PA2336EA, PA, UA OPA4336EA		OPA336NJ, UJ			
PARAMETER	CONDITION	MIN	TYP ⁽¹⁾	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
OFFSET VOLTAGE Input Offset Voltage Vos vs Temperature dV _{OS} /dT vs Power Supply PSRR Over Temperature Channel Separation, dc	$V_S = 2.3V \text{ to } 5.5V$ $V_S = 2.3V \text{ to } 5.5V$		±60 ± 1.5 25	±125		* * *	±500 * *	*	±500 * *	±2500 * *	μV μ V/°C μV/V μ V/V μV/V
INPUT BIAS CURRENT			±1	±10 ± 60 ±10		*	* *		*	* *	рА рА рА
$\label{eq:NOISE} \begin{split} &\text{NOISE} \\ &\text{Input Voltage Noise, f = 0.1 to 10Hz} \\ &\text{Input Voltage Noise Density, f = 1kHz } & e_n \\ &\text{Current Noise Density, f = 1kHz} & i_n \end{split}$			3 40 30			* *			* * *		μVp-p nV/√Hz fA/√Hz
INPUT VOLTAGE RANGE Common-Mode Voltage Range V _{CM} Common-Mode Rejection Ratio CMRR Over Temperature	$-0.2V < V_{CM} < (V+) -1V$ $-0.2V < V_{CM} < (V+) -1V$	-0.2 80 76	90	(V+) -1	* 76 74	86	*	* 76 74	86	*	V dB dB
INPUT IMPEDANCE Differential Common-Mode			10 ¹³ 2 10 ¹³ 4			*			*		$\Omega \parallel pF$ $\Omega \parallel pF$
OPEN-LOOP GAIN Open-Loop Voltage Gain A _{OL} Over Temperature	$R_L = 25k\Omega$, $100mV < V_O < (V+) - 100mV$ $R_L = 25k\Omega$, $100mV < V_O < (V+) - 100mV$ $R_L = 5k\Omega$, $500mV < V_O < (V+) - 500mV$	100 100 90 90	115 106		90 90 *	*		90 90 *	*		dB dB dB
Over Temperature FREQUENCY RESPONSE Gain-Bandwidth Product GBW Slew Rate SR Overload Recovery Time	$R_L = 5k\Omega$, $500mV < V_O < (V+) - 500mV$ $V_S = 5V, G = 1$ $V_S = 5V, G = 1$ $V_{IN} \bullet G = V_S$	90	100 0.03 100		*	* *		_ ~	* *		kHz V/μs μs
OUTPUT Voltage Output Swing from Rail ⁽²⁾ Over Temperature Over Temperature Short-Circuit Current Capacitive Load Drive CLOAD	$\begin{split} R_L &= 100 k \Omega, \ A_{OL} \geq 70 dB \\ R_L &= 25 k \Omega, \ A_{OL} \geq 90 dB \\ R_L &= 25 k \Omega, \ A_{OL} \geq 90 dB \\ R_L &= 5 k \Omega, \ A_{OL} \geq 90 dB \\ R_L &= 5 k \Omega, \ A_{OL} \geq 90 dB \end{split}$		3 20 70 ±5 See Text	100 100 500 500		* * * *	* * *		* * * *	* * *	mV mV mV mV mA pF
POWER SUPPLY Specified Voltage Range Vs Minimum Operating Voltage Quiescent Current (per amplifier) Iq Over Temperature	I _O = 0 I _O = 0	2.3	2.1 20	5.5 32 36	*	*	* *	*	* 23	* 38 42	V V μΑ μ Α
TEMPERATURE RANGE Specified Range Operating Range Storage Range Thermal Resistance θ _{JA} SOT-23-5 Surface-Mount MSOP-8 Surface-Mount SO-8 Surface-Mount DIP-8 SSOP-16 Surface-Mount		-40 -55 -55	200 150 150 100 100 80	+85 +125 +125	* *	* * * * *	* *	* * *	*	* * *	°C °

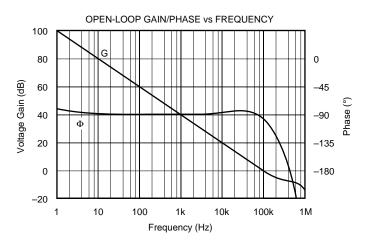
^{*}Specifications same as OPA2336E, P, U.

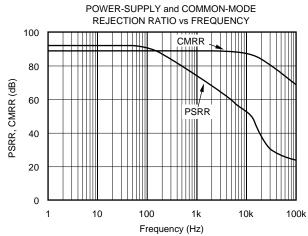
NOTES: (1) $V_S = +5V$. (2) Output voltage swings are measured between the output and positive and negative power-supply rails.

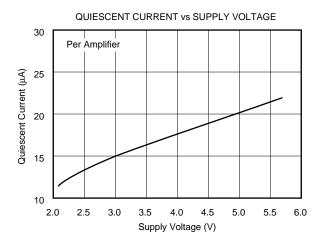


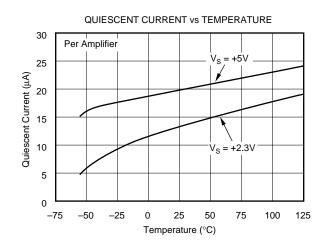
TYPICAL CHARACTERISTICS

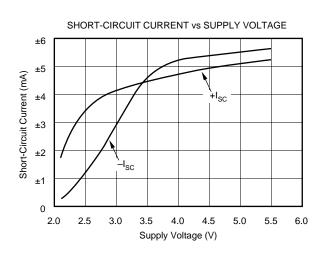
At T_A = +25°C, V_S = +5V, and R_L = 25k Ω connected to $V_S/2$, unless otherwise noted.

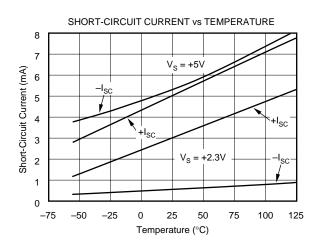








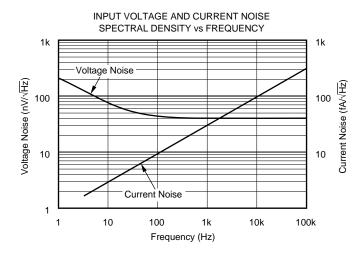


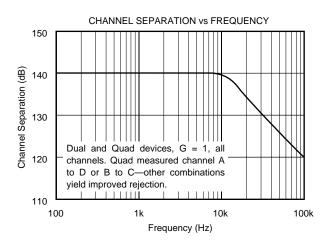


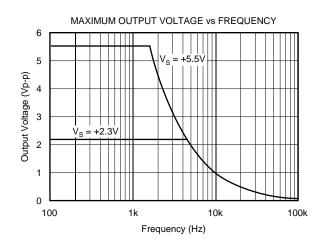


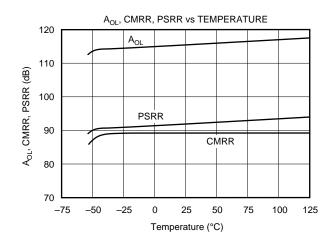
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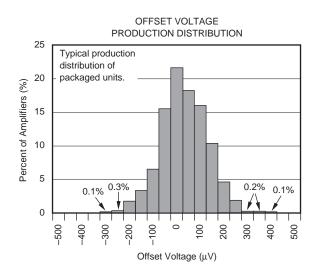
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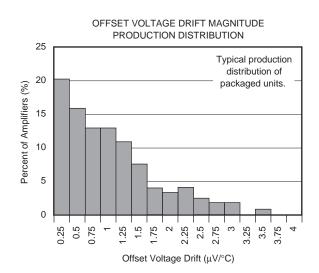








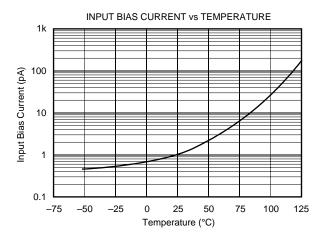


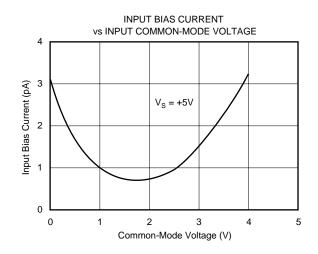


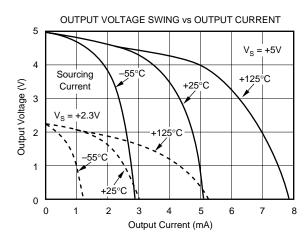


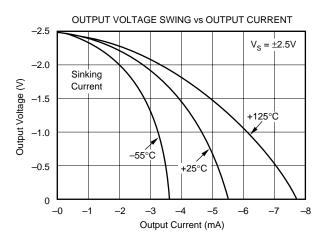
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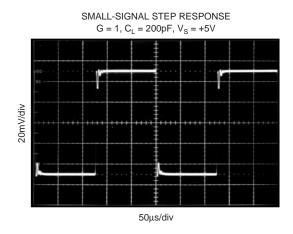
At T_A = +25°C, V_S = +5V, and R_L = 25k Ω connected to $V_S/2$, unless otherwise noted.

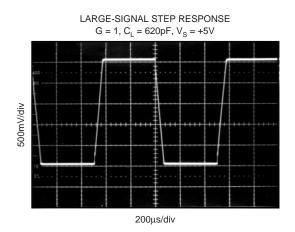












APPLICATIONS INFORMATION

OPA336 series op amps are fabricated on a state-of-the-art 0.6 micron CMOS process. They are unity-gain stable and suitable for a wide range of general-purpose applications. Power-supply pins should be bypassed with $0.01\mu F$ ceramic capacitors. OPA336 series op amps are protected against reverse battery voltages.

OPERATING VOLTAGE

OPA336 series op amps can operate from a +2.1V to +5.5V single supply with excellent performance. Most behavior remains unchanged throughout the full operating voltage range. Parameters which vary significantly with operating voltage are shown in the typical characteristics. OPA336 series op amps are fully specified for operation from +2.3V to +5.5V; a single limit applies over the supply range. In addition, many parameters are guaranteed over the specified temperature range, -40°C to +85°C.

INPUT VOLTAGE

The input common-mode range of OPA336 series op amps extends from (V-) – 0.2V to (V+) – 1V. For normal operation, inputs should be limited to this range. The absolute maximum input voltage is 300mV beyond the supplies. Thus, inputs greater than the input common-mode range but less than maximum input voltage, while not valid, will not cause any damage to the op amp. Furthermore, the inputs may go beyond the power supplies without phase inversion, as shown in Figure 1, unlike some other op amps.

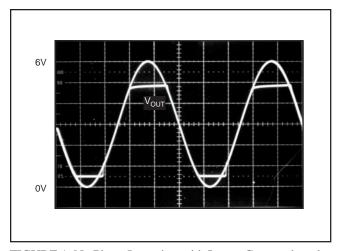


FIGURE 1. No Phase Inversion with Inputs Greater than the Power-Supply Voltage.

Normally, input bias current is approximately 1pA. However, input voltages exceeding the power supplies can cause excessive current to flow in or out of the input pins. Momentary voltages greater than the power supply can be tolerated as long as the current on the input pins is limited to 10mA. This is easily accomplished with an input resistor, as shown in Figure 2.

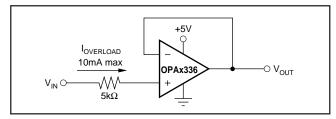


FIGURE 2. Input Current Protection for Voltages Exceeding the Supply Voltage.

CAPACITIVE LOAD AND STABILITY

OPA336 series op amps can drive a wide range of capacitive loads. However, all op amps under certain conditions may become unstable. Op-amp configuration, gain, and load value are just a few of the factors to consider when determining stability.

When properly configured, OPA336 series op amps can drive approximately 10,000pF. An op amp in unity-gain configuration is the most vulnerable to capacitive load. The capacitive load reacts with the op amp's output resistance, along with any additional load resistance, to create a pole in the response which degrades the phase margin. In unity gain, OPA336 series op amps perform well with a pure capacitive load up to about 300pF. Increasing gain enhances the amplifier's ability to drive loads beyond this level.

One method of improving capacitive load drive in the unity-gain configuration is to insert a 50Ω to 100Ω resistor inside the feedback loop, as shown in Figure 3. This reduces ringing with large capacitive loads while maintaining DC

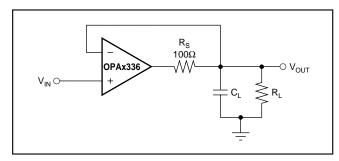


FIGURE 3. Series Resistor in Unity-Gain Configuration Improves Capacitive Load Drive.



accuracy. For example, with $R_L = 25 k\Omega$, OPA336 series op amps perform well with capacitive loads in excess of 1000pF, as shown in Figure 4. Without R_S , capacitive load drive is typically 350pF for these conditions, as shown in Figure 5.

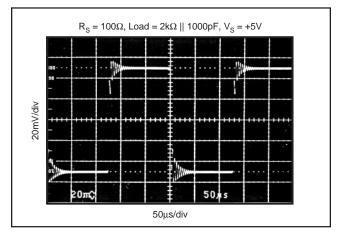


FIGURE 4. Small-Signal Step Response Using Series Resistor to Improve Capacitive Load Drive.

Alternatively, the resistor may be connected in series with the output outside of the feedback loop. However, if there is a resistive load parallel to the capacitive load, it and the series resistor create a voltage divider. This introduces a Direct Current (DC) error at the output, however, this error may be insignificant. For instance, with $R_L=100k\Omega$ and $R_S=100\Omega$, there is only about a 0.1% error at the output.

Figure 5 shows the recommended operating regions for the OPA336. Decreasing the load resistance generally improves capacitive load drive. Figure 5 also illustrates how stability differs depending on where the resistive load is connected. With G = +1 and $R_L = 10 k \Omega$ connected to $V_S/2$, the OPA336 can typically drive 500pF. Connecting the same load to ground improves capacitive load drive to 1000pF.

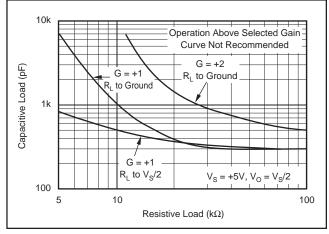


FIGURE 5. Stability—Capacitive Load vs Resistive Load.





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PACKAGING INFORMATION

				PINS	PACKAGE QTY	
OPA2336E/250	ACTIVE	VSSOP	SSOP DGK		250	
OPA2336E/2K5	ACTIVE	VSSOP	DGK	8	2500	
OPA2336EA/250	ACTIVE	VSSOP	DGK	8	250	
OPA2336EA/2K5	ACTIVE	VSSOP	DGK	8	2500	
OPA2336P	ACTIVE	PDIP	Р	8	50	
OPA2336PA	ACTIVE	PDIP	Р	8	50	
OPA2336U	ACTIVE	SOIC	D	8	100	
OPA2336U/2K5	ACTIVE	SOIC	D	8	2500	
OPA2336UA	ACTIVE	SOIC	D	8	100	
OPA2336UA/2K5	ACTIVE	SOIC	D	8	2500	
OPA336N/250	ACTIVE	SOP	DBV	5	250	
OPA336N/3K	ACTIVE	SOP	DBV	5	3000	
OPA336NA/250	ACTIVE	SOP	DBV	5	250	
OPA336NA/3K	ACTIVE	SOP	DBV	5	3000	
OPA336NJ/250	ACTIVE	SOP	DBV	5	250	
OPA336NJ/3K	ACTIVE	SOP	DBV	5	3000	
OPA336P	OBSOLETE	PDIP	Р	8		
OPA336PA	OBSOLETE	PDIP	Р	8		
OPA336U	ACTIVE	SOIC	D	8	100	
OPA336U/2K5	ACTIVE	SOIC	D	8	2500	
OPA336UA	ACTIVE	SOIC	D	8	100	
OPA336UA/2K5	ACTIVE	SOIC	D	8	2500	
OPA336UJ	PREVIEW	SOIC	D	8	100	
OPA336UJ/2K5	PREVIEW	SOIC	D	8	2500	
OPA4336EA/250	ACTIVE	SSOP	DBQ	16	250	
OPA4336EA/2K5	ACTIVE	SSOP	DBQ	16	2500	
OPA4336PA	OBSOLETE	PDIP	N	14		

(1) The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



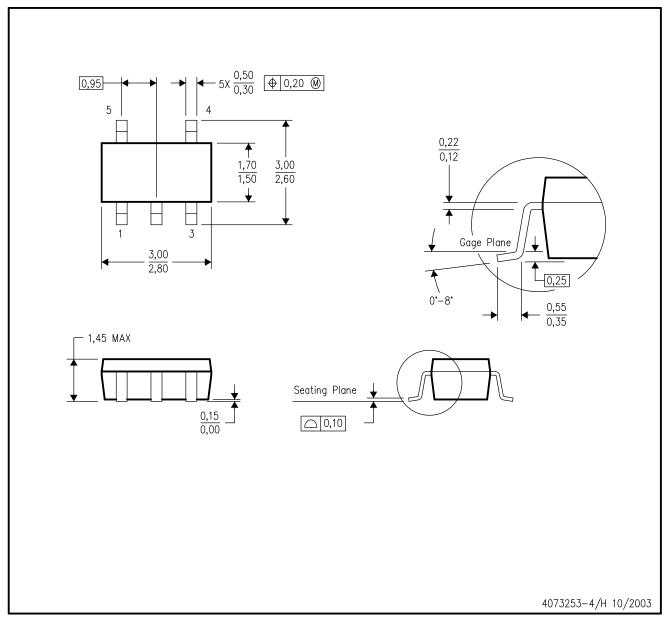
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



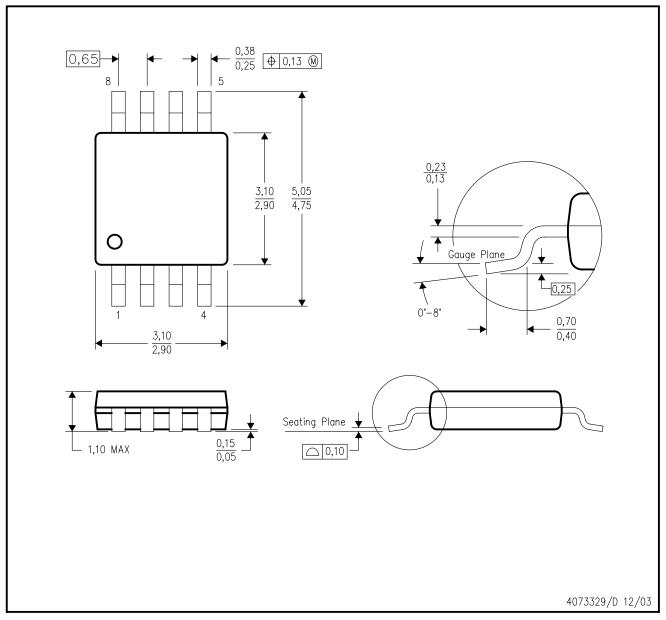
NOTES:

- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- C. Body dimensions do not include mold fla D. Falls within JEDEC MO—178 Variation AA. Body dimensions do not include mold flash or protrusion.



DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

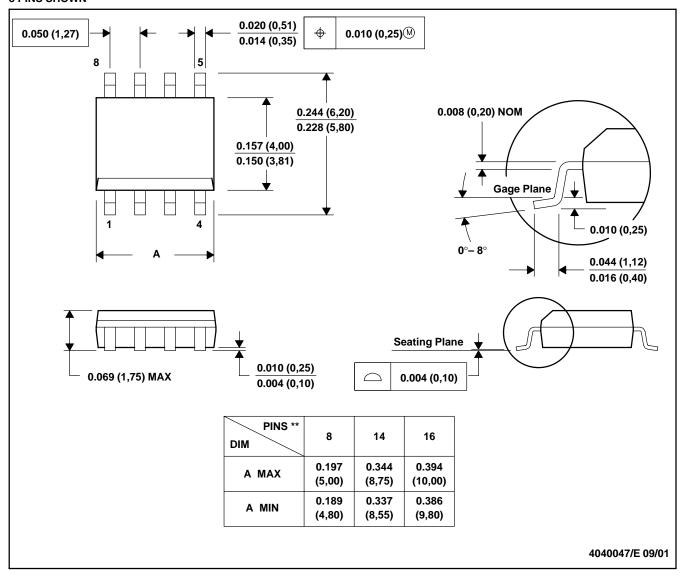
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-187 variation AA.



D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

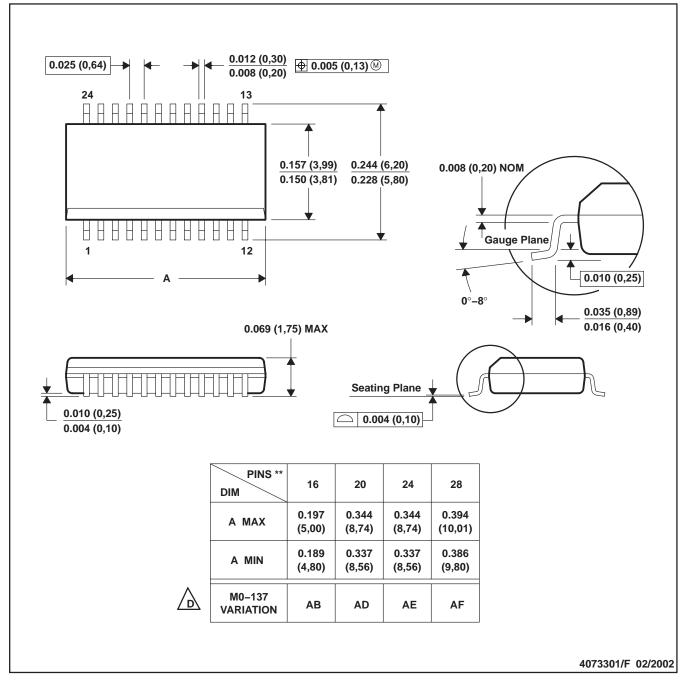
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

DBQ (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-137.



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